



Product Change Notification

Change Notification #: 117622 - 00
Change Title: Select Intel® Optane™ SSD DC P4801X Series Products, PCN 117622-00, Product Design, Firmware Update
Date of Publication: June 5, 2020

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	July 6, 2020
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Description of Change to the Customer:

The Intel® Optane™ SSD DC P4801X Series SKUs listed in the Products Affected table below will have the firmware version updated from E2010450 to E2010485. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® Optane™ SSD DC P4801X Series (375GB, M.2 110mm PCIe x4, 3D XPoint™, 60DWPD) Generic Single Pack	SSDPEL1K375GA01	958880	J76414-100	J76417-100	J76414-101	J76417-101
Intel® Optane™ SSD DC P4801X Series (100GB, M.2 110mm PCIe x4, 3D XPoint™, 60DWPD) Generic Single Pack	SSDPEL1K100GA01	964887	J88294-100	J88297-100	J88294-101	J88297-101
Intel® Optane™ SSD DC P4801X Series (200GB, M.2 110mm PCIe x4, 3D XPoint™, 60DWPD) Generic Single Pack	SSDPEL1K200GA01	964892	J88295-100	J88298-100	J88295-101	J88298-101
Intel® Optane™ SSD DC P4801X Series (100GB, M.2 110mm PCIe x4, 3D XPoint™, 60DWPD) with Heat Spreader, Generic Single Pack	SSDPEL1C100GA01	985978	K65886-100	K65889-100	K65886-101	K65889-101
Intel® Optane™ SSD DC P4801X Series (200GB, M.2 110mm PCIe x4, 3D XPoint™, 60DWPD) with Heat Spreader, Generic Single Pack	SSDPEL1C200GA01	986008	K65887-100	K65890-100	K65887-101	K65890-101
Intel® Optane™ SSD DC P4801X Series (375GB, M.2 110mm PCIe x4, 3D XPoint™, 60DWPD) with Heat Spreader, Generic Single Pack	SSDPEL1C375GA01	986009	K65888-100	K65891-100	K65888-101	K65891-101

PCN Revision History:

Date of Revision:

June 5, 2020

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

117622 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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